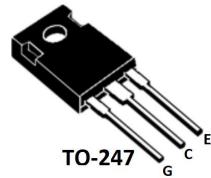


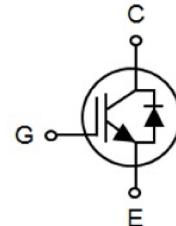
Features

- Low gate charge
 - Trench-Stop Technology
 - High speed switching
- Saturation voltage: V_{CE(sat)}, typ = 1.5V



Applications

- General purpose inverters
- Induction heating(IH)
- Welding Converters
- UPS



Absolute Ratings (T_c=25°C)

Parameter	Symbol	MSG80D60FLC		Unit	
Collector-Emitter Voltage	V _{CES}	600		V	
Collector Current-continuous	I _C T=25°C	180		A	
	T=100°C	80		A	
Collector Current-pulse(note 1)	I _{CM}	300		A	
Gate-emitter voltage	V _{GES}	±30		V	
Diode RMS forward current	I _F T=25°C	180		A	
	T=100°C	80		A	
Diode Forward Current	T=100°C	80		A	
Power Dissipation	P _D T _c =25°C	260		W	
Operating Temperature Range	T _J	-55~+150		°C	
Storage Temperature Range	T _{STG}	-55~150		°C	
Maximum Lead Temperature for Soldering Purposes	T _L	300		°C	

Thermal Characteristic

Parameter	Symbol	Tests conditions	Min	Typ	Max	Units
Off-Characteristics						
Collector-Emitter Voltage	BV _{CES}	I _C =250μA, V _{GE} =0V	600	-	-	V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} =V _{CES} ,			25	μA
		V _{GE} =0V, T _J =125°C			250	
Gate-body leakage current	I _{GES}	V _{CE} =0V, V _{GE} =±20V	-	-	±100	nA

Transconductance	gfs	V _{CE} =10V,I _C =50A	30	48	-	S
On-Characteristics						
Gate-Emitter Threshold Voltage	V _{GE(th)}	V _{CE} =V _{GE} , I _C =250uA	3.0	-	5.0	V
Collector-Emitter saturation Voltage	V _{CESAT}	V _{GE} =15V,I _C =30A		1.1	1.2	V
		V _{GE} =15V,I _C =50A		1.2	1.3	
		V _{GE} =15V,I _C =80A		1.5	1.6	
Dynamic Characteristics						
Input capacitance	C _{ies}	V _{CE} =25V, V _{GE} =0V, f=1.0MHZ	-	3190	-	pF
Output capacitance	C _{oes}		-	175	-	pF
Reverse transfer capacitance	C _{res}		-	43	-	pF
Switching Characteristics						
Turn-On delay time	t _{d(on)}	V _{CE} =480V,I _C =60A, R _G =5Ω, V _{GE} =15.0V T _J =25°C Inductive Load	-	25	-	ns
Turn-On rise time	t _r		-	30	-	ns
Turn-off delay time	t _{d(off)}		-	334	-	ns
Turn-off Fall time	t _f		-	224	-	ns
Turn-on energy	E _{on}		-	0.95	-	mJ
Turn-off energy	E _{off}		-	2.90	-	mJ
Total Gate Charge	Q _g		-	110	-	nC
Gate to emitter charge	Q _{ge}		-	21	-	nC
Gate to collector charge	Q _{gc}		-	42	-	nC

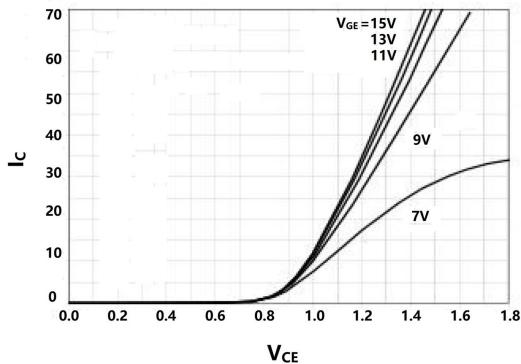
Parameter	Symbol	Max	Unit
IGBT Thermal Resistance,Junction to Case	R _{th(j-c)}	0.48	K/W
Diode Thermal Resistance,Junction to Case	R _{th(j-c)}	1.1	K/W
Thermal Resistance,Junction to Ambient	R _{th(j-A)}	40	K/W

Notes:

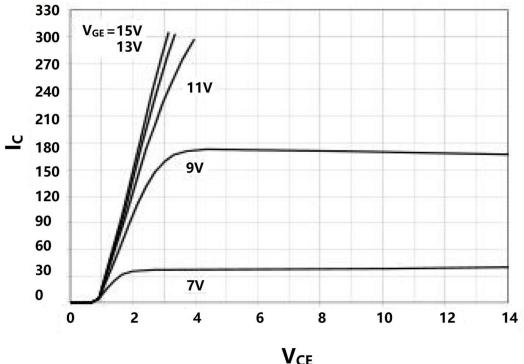
- 1: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width ≤300μs,Duty Cycle≤2%
- 3: Essentially independent of operating temperature

Electrical Characteristics (curves)

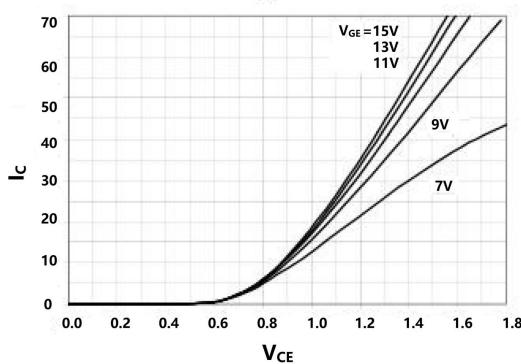
Output Characteristics @25°C



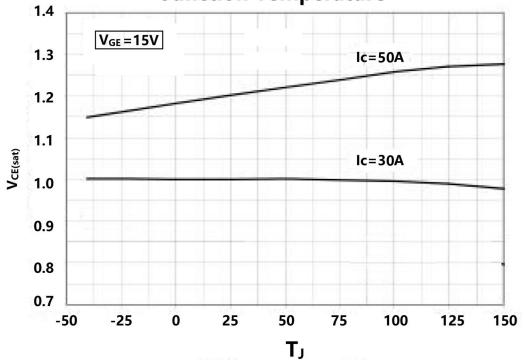
Extended Output Characteristics @25°C



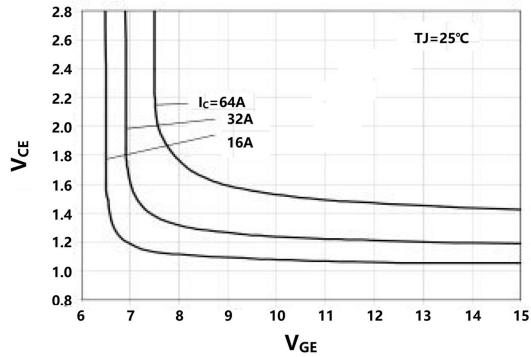
Output Characteristics @125°C



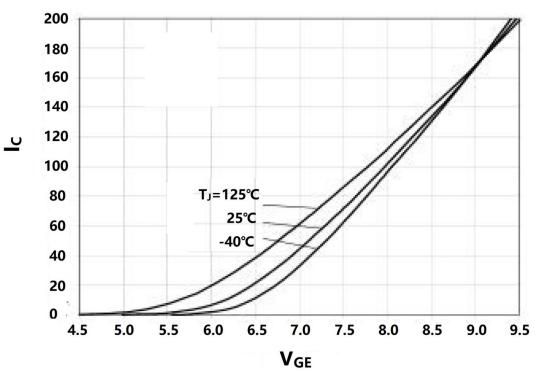
Dependence of $V_{CE(sat)}$ on Junction Temperature



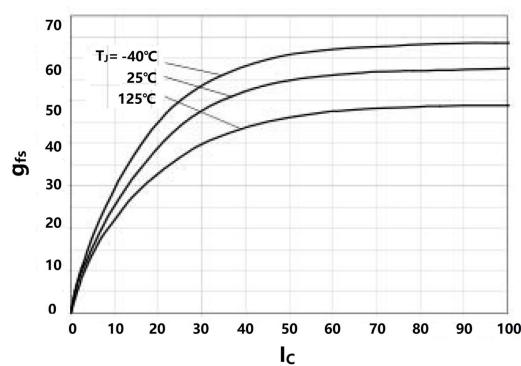
Collector to Emitter Voltage vs. Gate to Emitter Voltage



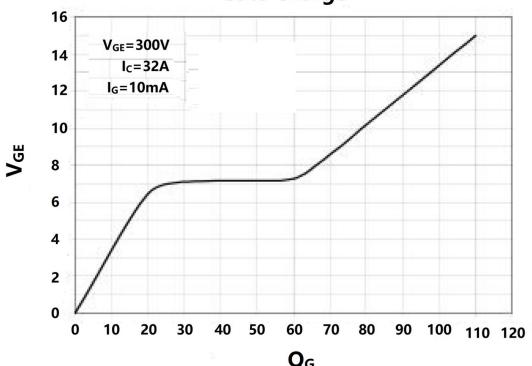
Input Admittance

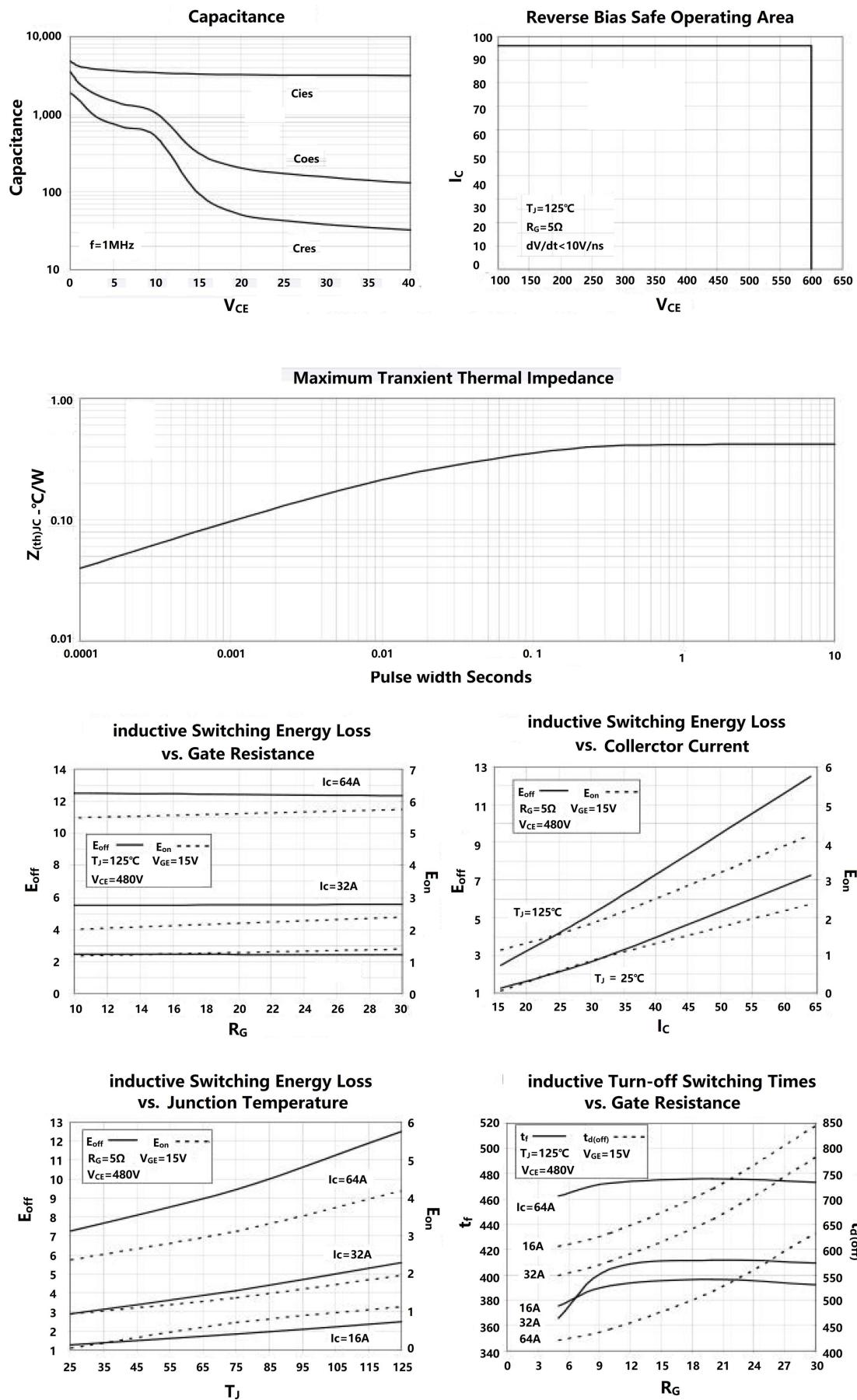


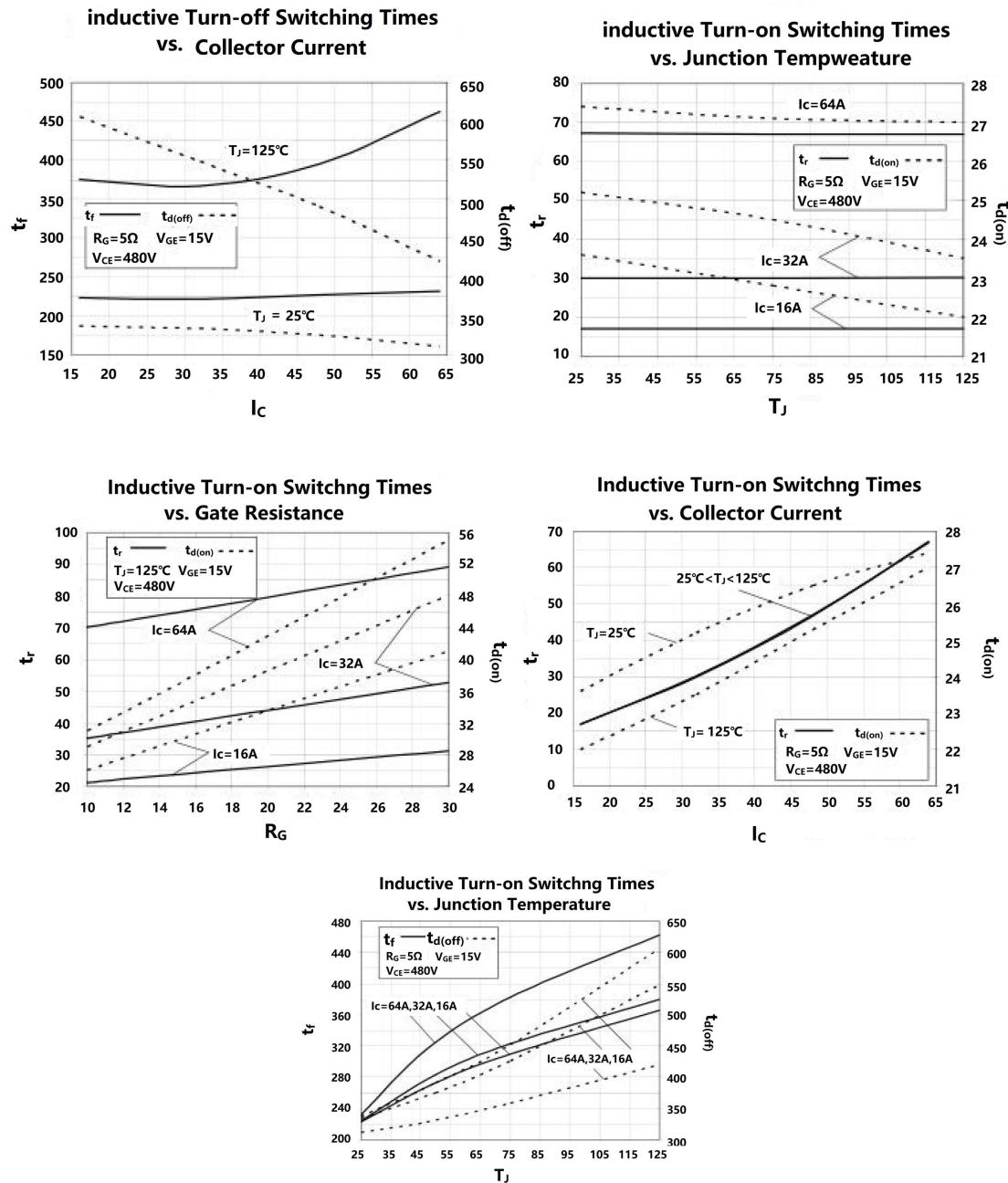
Transconductance



Gate Charge







Package Mechanical DATA

